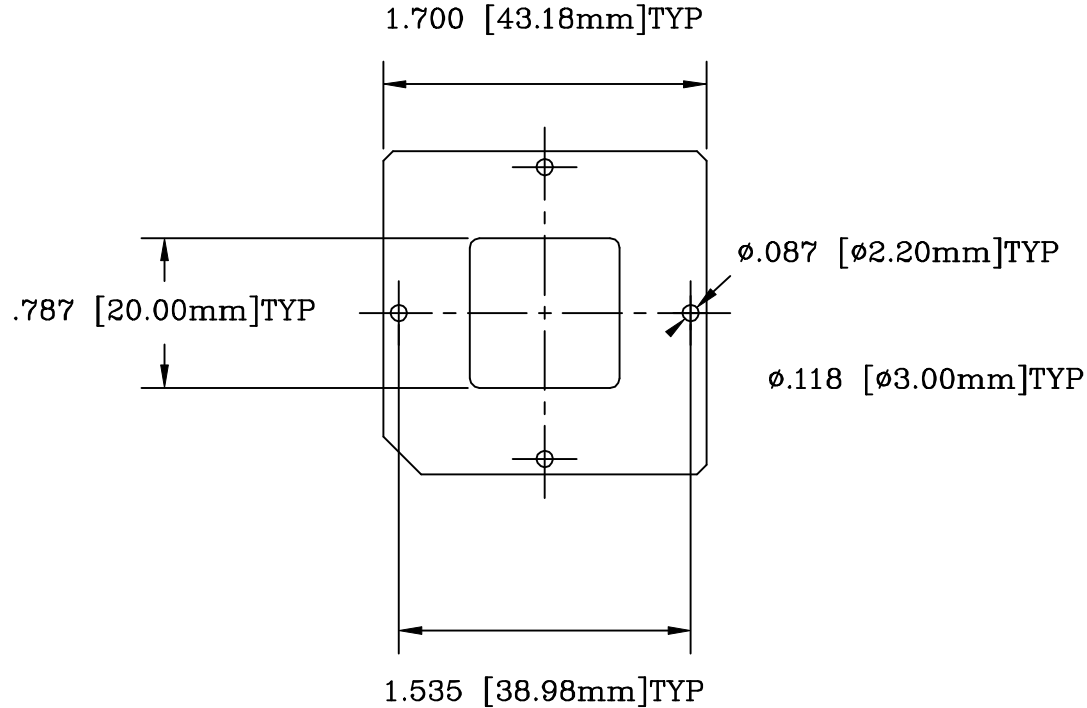
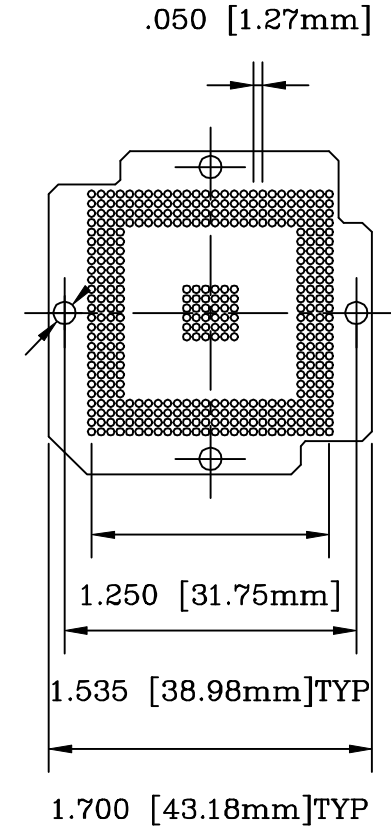
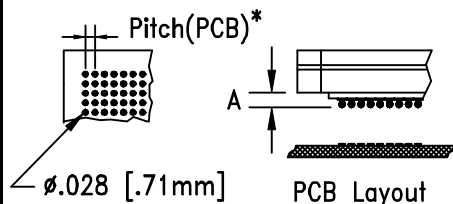
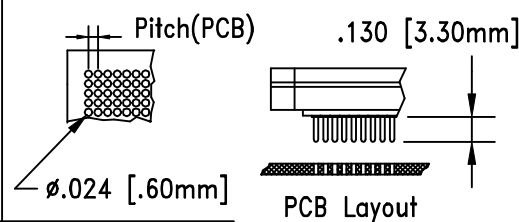


RETENTION FRAMESOCKETRECOMMENDED PAD LAYOUT

SMT STYLE
-29(RC) & -30(SM) TYPE



THRU HOLE STYLE
-70(ET) TYPE



XX(YY)= SOLDERTAIL STYLE

30= standard SMD ("A" = .047 [1.20mm])
29= raised SMD ("A" = .197 [5.00mm])

PIN DIAMETER FOR -70(ET)=.018 [.45mm]
BALL DIAMETER FOR -29(RC) & -30(SM)=.026 [.66mm]

* The pitch dimension depends on your Ball Grid Array

ALL DIMENSIONS ARE IN INCHES UNLESS OTHERWISE SPECIFIED



Emulation Technology, Inc.
— VLSI and SMT ADAPTERS and ACCESSORIES —

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SHEET:
1 OF 1

DATE:
8/15/00

REVISION:

ASSEMBLY DRAWING

CHECKED:
Paula Olson

DRAWN:
Aaron Fine

ITEM: S-BGA-26-388-YY

DESCRIPTION:
BPW-388-2BG026-XX

DO NOT SCALE DRAWING